

## N- and P-Channel 20-V (D-S) MOSFET

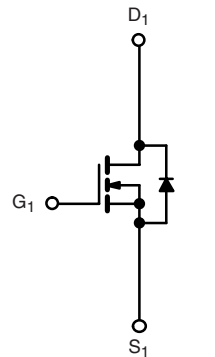
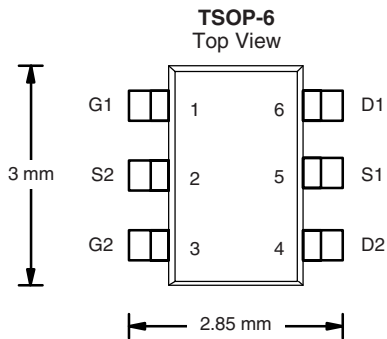
PRODUCT SUMMARY			
	V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)
N-Channel	20	0.125 at V <sub>GS</sub> = 4.5 V	2.4
		0.200 at V <sub>GS</sub> = 2.5 V	1.8
P-Channel	- 20	0.200 at V <sub>GS</sub> = - 4.5 V	- 1.8
		0.340 at V <sub>GS</sub> = - 2.5 V	- 1.2

### FEATURES

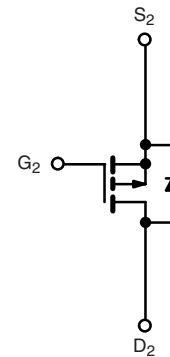
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available



N-Channel MOSFET



P-Channel MOSFET

Ordering Information: Si3585DV-T1-E3 (Lead (Pb)-free)  
Si3585DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	N-Channel		P-Channel		Unit	
		10 s	Steady State	10 s	Steady State		
Drain-Source Voltage	V <sub>DS</sub>	20		- 20		V	
Gate-Source Voltage	V <sub>GS</sub>	± 12		± 12			
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	I <sub>D</sub>	T <sub>A</sub> = 25 °C	2.4	2.0	- 1.8	- 1.5	A
		T <sub>A</sub> = 70 °C	1.7	1.4	- 1.3	- 1.2	
Pulsed Drain Current	I <sub>DM</sub>	8		- 7		A	
Continuous Source Current (Diode Conduction) <sup>a</sup>	I <sub>S</sub>	1.05	0.75	- 1.05	- 0.75		
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	T <sub>A</sub> = 25 °C	1.15	0.83	1.15	0.83	W
		T <sub>A</sub> = 70 °C	0.59	0.53	0.59	0.53	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150				°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	N-Channel		P-Channel		Unit	
		Typ.	Max.	Typ.	Max.		
Maximum Junction-to-Ambient <sup>a</sup>	R <sub>thJA</sub>	t ≤ 10 s	93	110	93	110	°C/W
		Steady State	130	150	130	150	
Maximum Junction-to-Foot (Drain)	R <sub>thJF</sub>	75	90	75	90		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

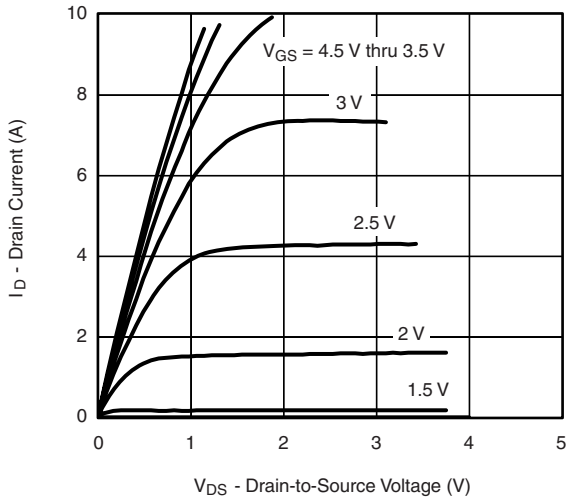
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
<b>Static</b>							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	N-Ch	0.6			V
		$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$	P-Ch	-0.5			
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\ \text{V}, V_{GS} = \pm 12\ \text{V}$	N-Ch P-Ch		$\pm 100$ $\pm 100$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 16\ \text{V}, V_{GS} = 0\ \text{V}$	N-Ch		1	$\mu\text{A}$	
		$V_{DS} = -16\ \text{V}, V_{GS} = 0\ \text{V}$	P-Ch		-1		
		$V_{DS} = 16\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 55\text{ }^\circ\text{C}$	N-Ch		5		
		$V_{DS} = -16\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 55\text{ }^\circ\text{C}$	P-Ch		-5		
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} \geq 5\ \text{V}, V_{GS} = 4.5\ \text{V}$	N-Ch	5		A	
		$V_{DS} \leq -5\ \text{V}, V_{GS} = -4.5\ \text{V}$	P-Ch	-5			
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = 4.5\ \text{V}, I_D = 2.4\ \text{A}$	N-Ch		0.100	0.125	$\Omega$
		$V_{GS} = -4.5\ \text{V}, I_D = -1.8\ \text{A}$	P-Ch		0.160	0.200	
		$V_{GS} = 2.5\ \text{V}, I_D = 1.8\ \text{A}$	N-Ch		0.160	0.200	
		$V_{GS} = -2.5\ \text{V}, I_D = -1.2\ \text{A}$	P-Ch		0.280	0.340	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = 5\ \text{V}, I_D = 2.4\ \text{A}$	N-Ch		5	S	
		$V_{DS} = -5\ \text{V}, I_D = -1.8\ \text{A}$	P-Ch		3.6		
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 1.05\ \text{A}, V_{GS} = 0\ \text{V}$	N-Ch		0.80	1.10	V
		$I_S = -1.05\ \text{A}, V_{GS} = 0\ \text{V}$	P-Ch		-0.83	-1.10	
<b>Dynamic<sup>b</sup></b>							
Total Gate Charge	$Q_g$	N-Channel $V_{DS} = 10\ \text{V}, V_{GS} = 4.5\ \text{V}, I_D = 2.4\ \text{A}$	N-Ch		2.1	3.2	nC
Gate-Source Charge	$Q_{gs}$		P-Ch		2.7	4.0	
Gate-Drain Charge	$Q_{gd}$	P-Channel $V_{DS} = -10\ \text{V}, V_{GS} = -4.5\ \text{V}, I_D = -1.8\ \text{A}$	N-Ch		0.3		
			P-Ch		0.4		
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 10\ \text{V}, R_L = 10\ \Omega$ $I_D \cong 1\ \text{A}, V_{GEN} = 4.5\ \text{V}, R_g = 6\ \Omega$	N-Ch		10	17	
			P-Ch		11	17	
Rise Time	$t_r$	P-Channel $V_{DD} = -10\ \text{V}, R_L = 10\ \Omega$ $I_D \cong -1\ \text{A}, V_{GEN} = -4.5\ \text{V}, R_g = 6\ \Omega$	N-Ch		30	50	ns
			P-Ch		34	50	
Turn-Off Delay Time	$t_{d(off)}$	N-Channel $V_{DD} = 10\ \text{V}, R_L = 10\ \Omega$ $I_D \cong 1\ \text{A}, V_{GEN} = 4.5\ \text{V}, R_g = 6\ \Omega$	N-Ch		14	25	
			P-Ch		19	30	
Fall Time	$t_f$	P-Channel $V_{DD} = -10\ \text{V}, R_L = 10\ \Omega$ $I_D \cong -1\ \text{A}, V_{GEN} = -4.5\ \text{V}, R_g = 6\ \Omega$	N-Ch		6	12	
			P-Ch		24	36	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 1.05\ \text{A}, dI/dt = 100\ \text{A}/\mu\text{s}$	N-Ch		30	50	
		$I_F = -1.05\ \text{A}, dI/dt = 100\ \text{A}/\mu\text{s}$	P-Ch		20	40	

Notes:

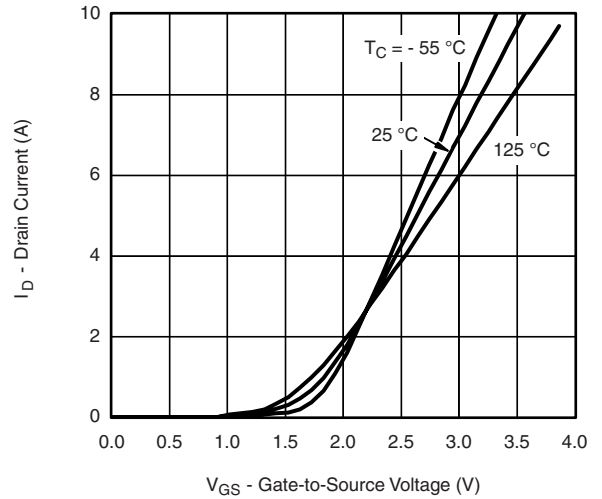
- a. Pulse test; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .  
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

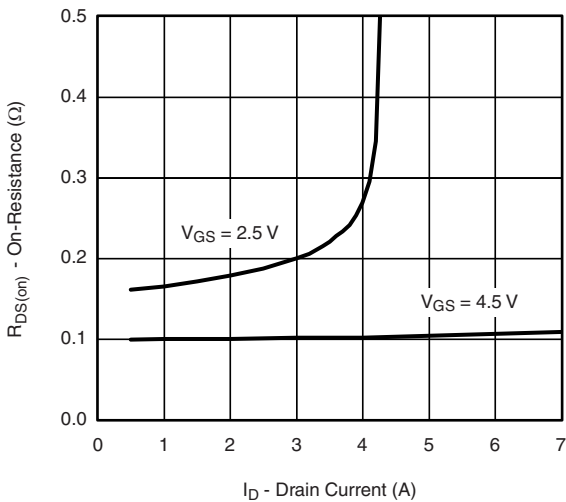
## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



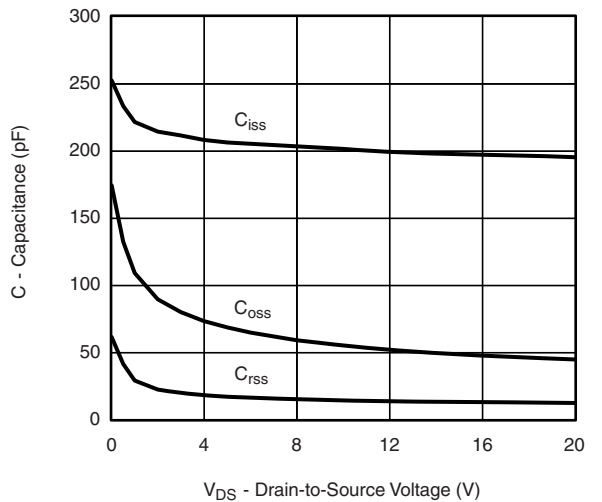
**Output Characteristics**



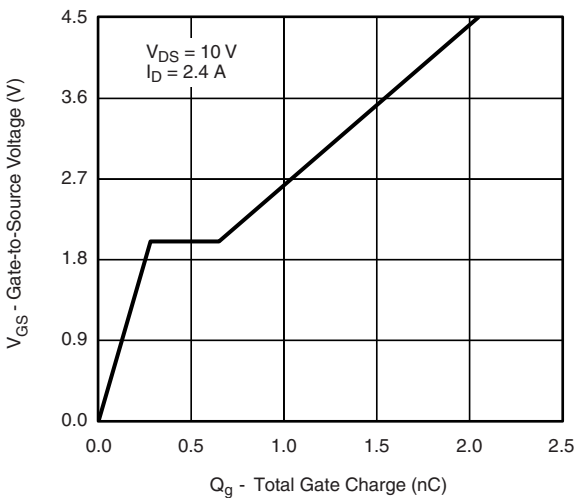
**Transfer Characteristics**



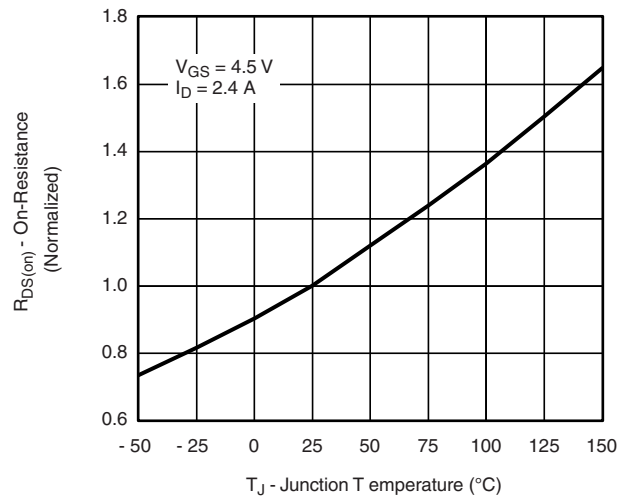
**On-Resistance vs. Drain Current**



**Capacitance**

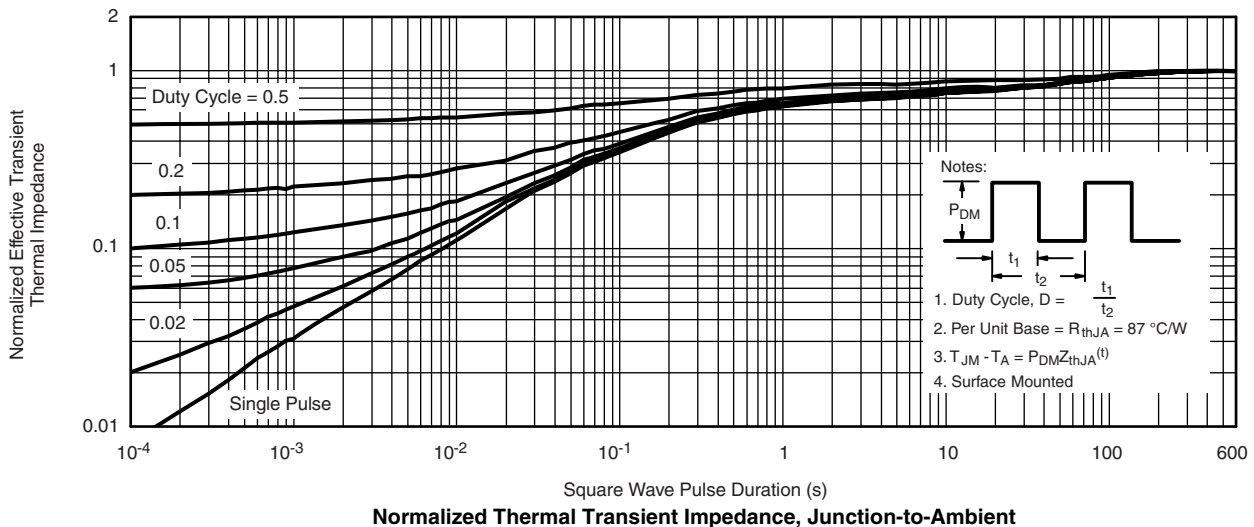
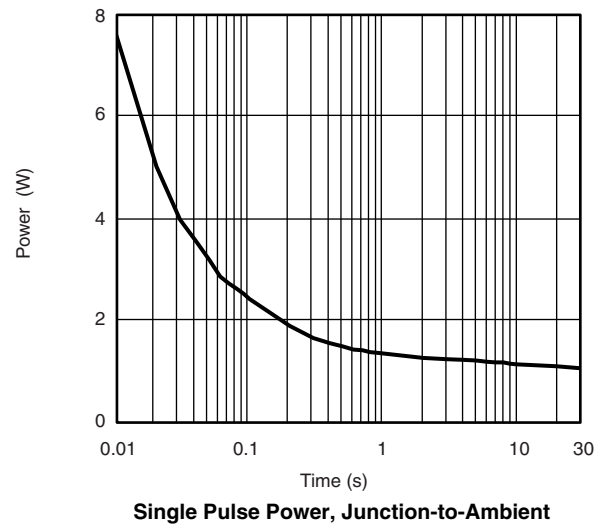
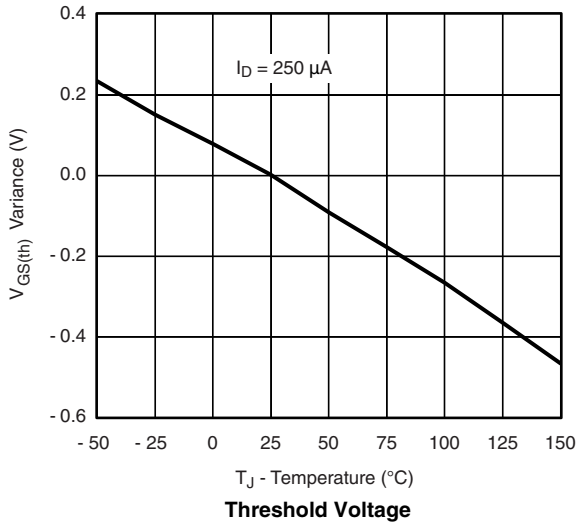
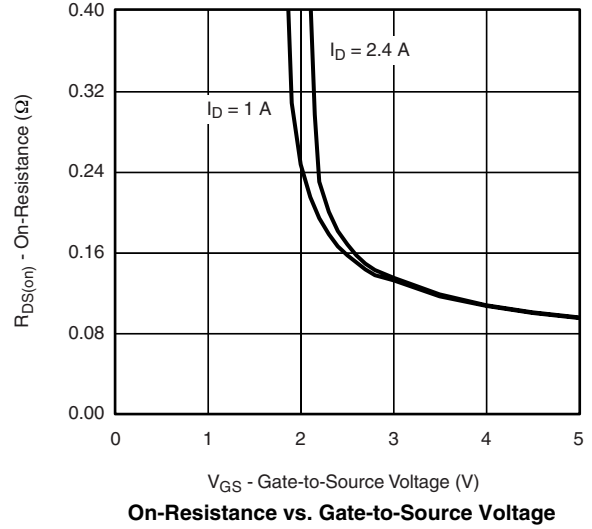
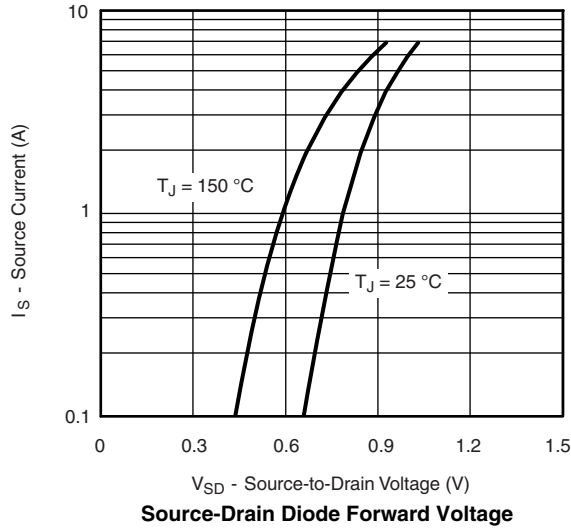


**Gate Charge**

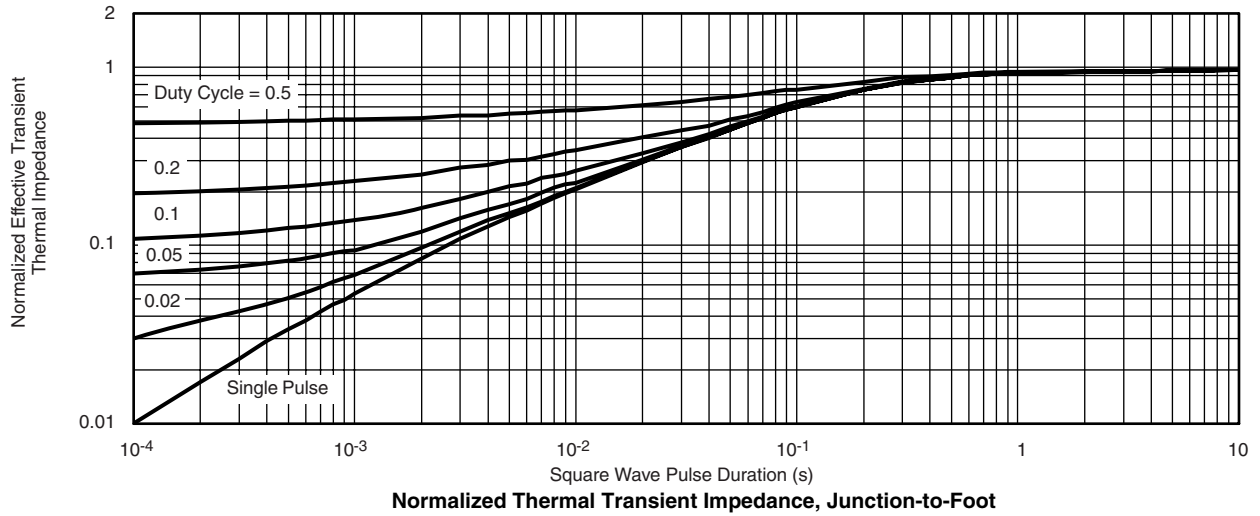


**On-Resistance vs. Junction Temperature**

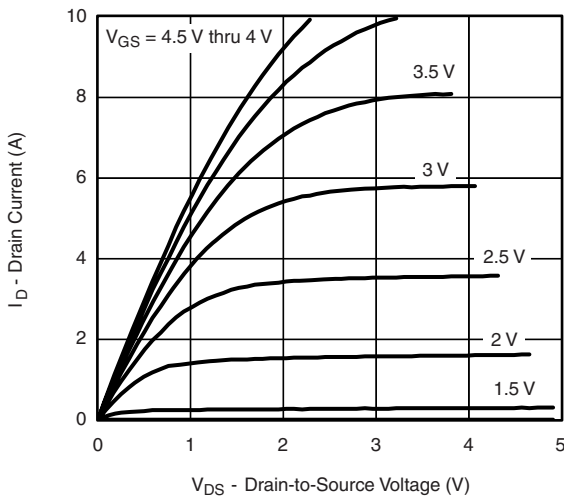
**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



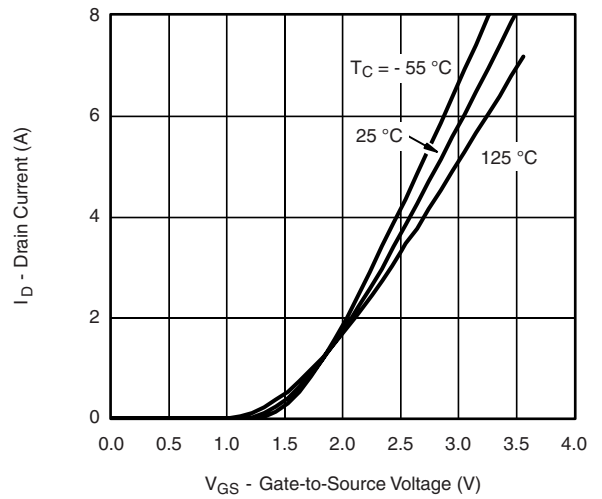
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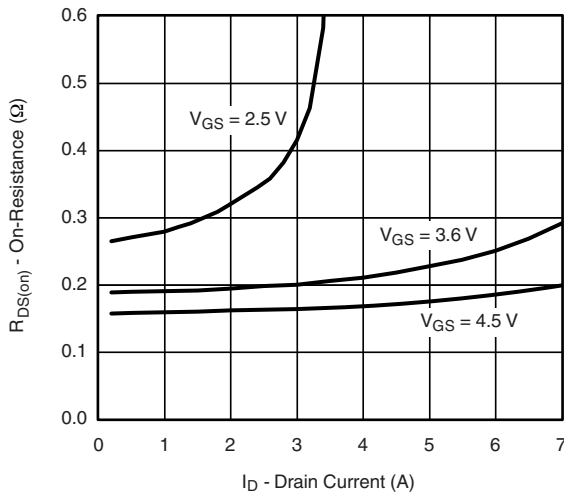
**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



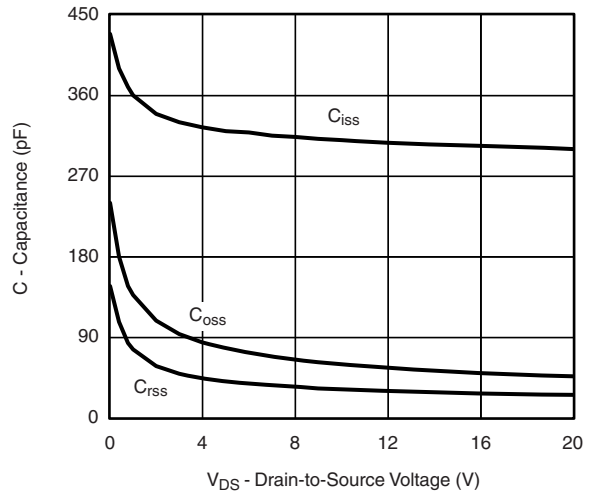
**Output Characteristics**



**Transfer Characteristics**

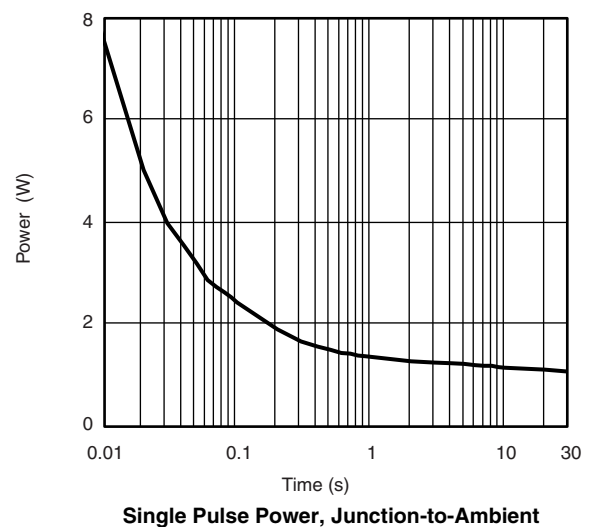
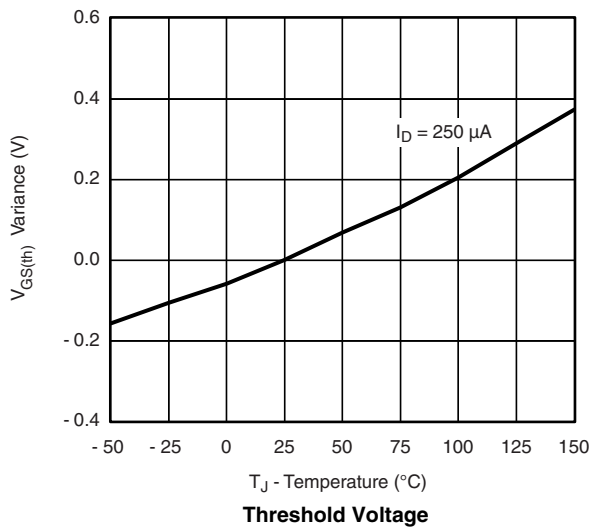
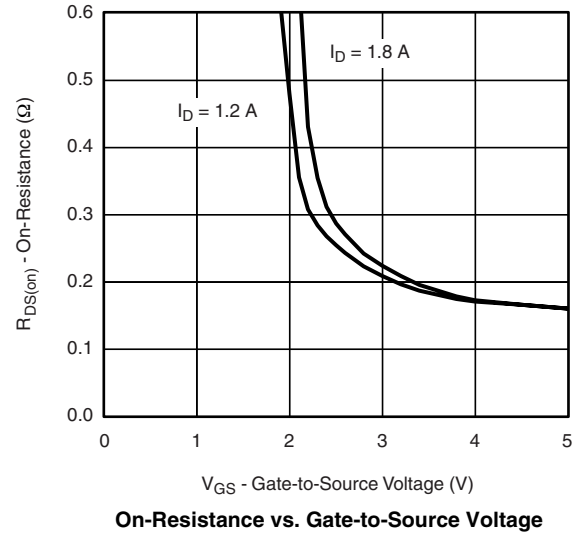
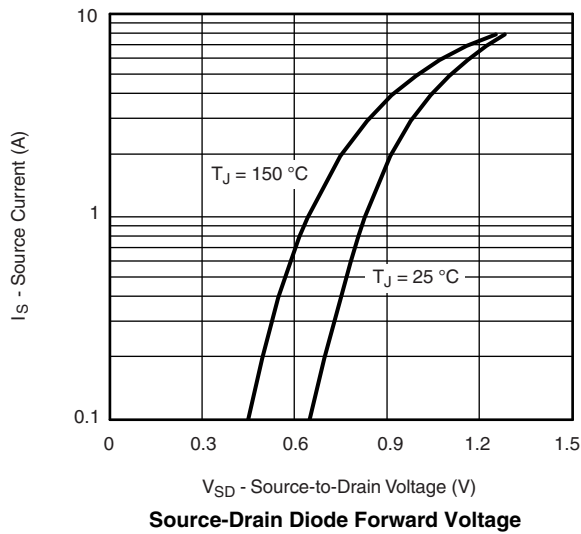
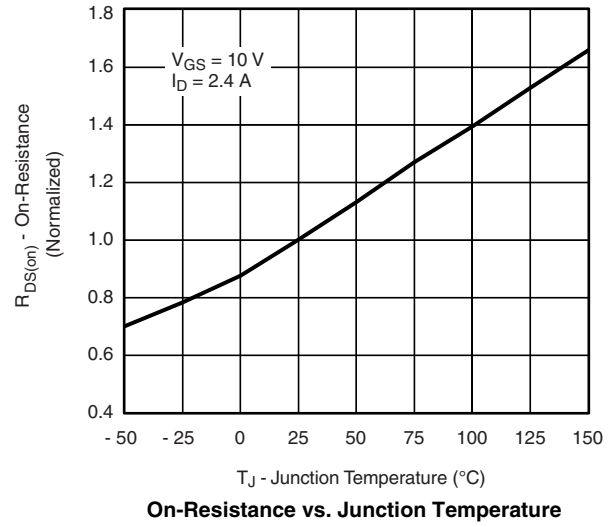
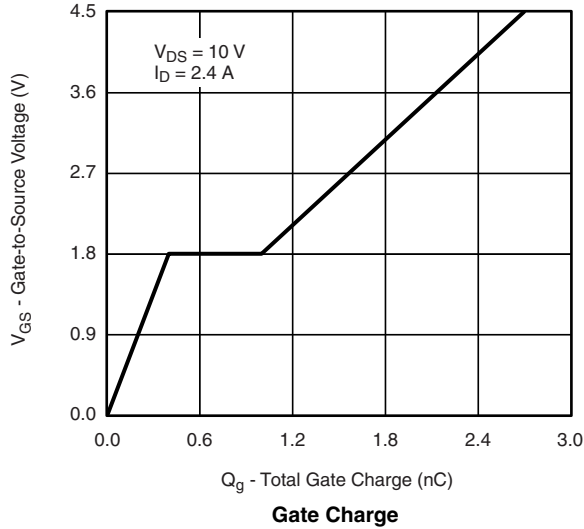


**On-Resistance vs. Drain Current**

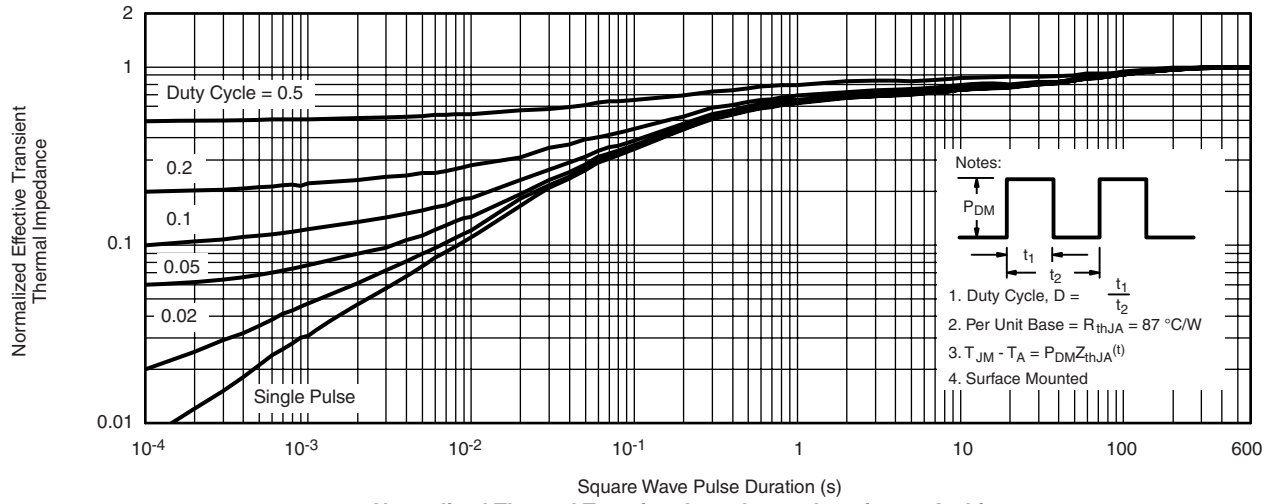


**Capacitance**

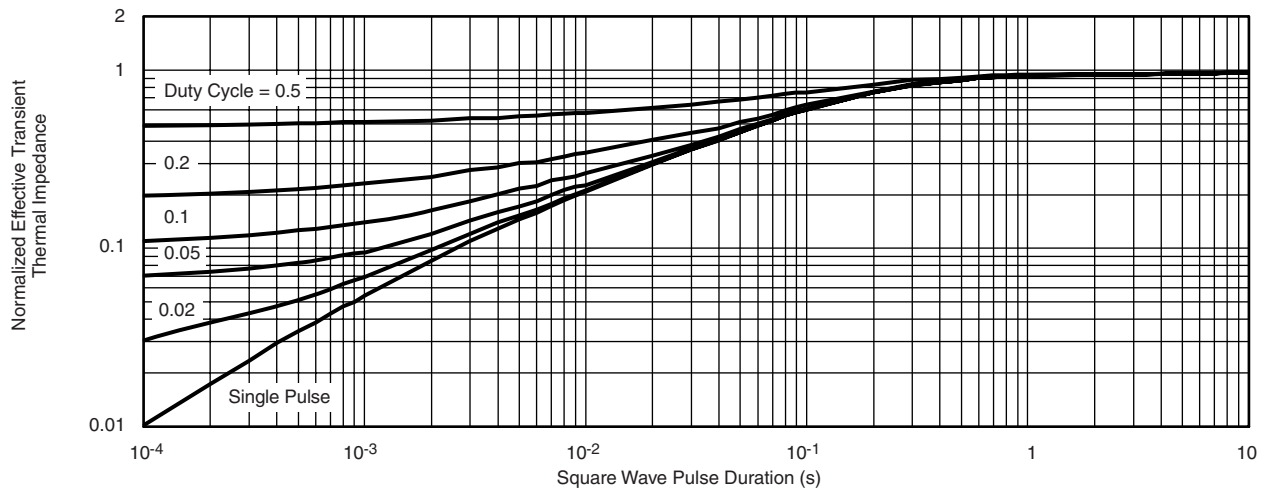
**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Foot**

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